DATASHEET

Technical Data Sheet
Mini-Top Infrared LEDs-RoHS Compliance
HIR16-213C/L423/TR8

Features

- High reliability
- Small double-end package
- Package in 8mm tape on 7” diameter reel
- Compatible with infrared and vapor phase reflow solder process.
- Pb free
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)

Description

- HIR16-213C/L423/TR8 is an infrared emitting diode in miniature SMD package which is molded in a water clear epoxy. The device is spectrally matched with silicon photodiode and phototransistor.

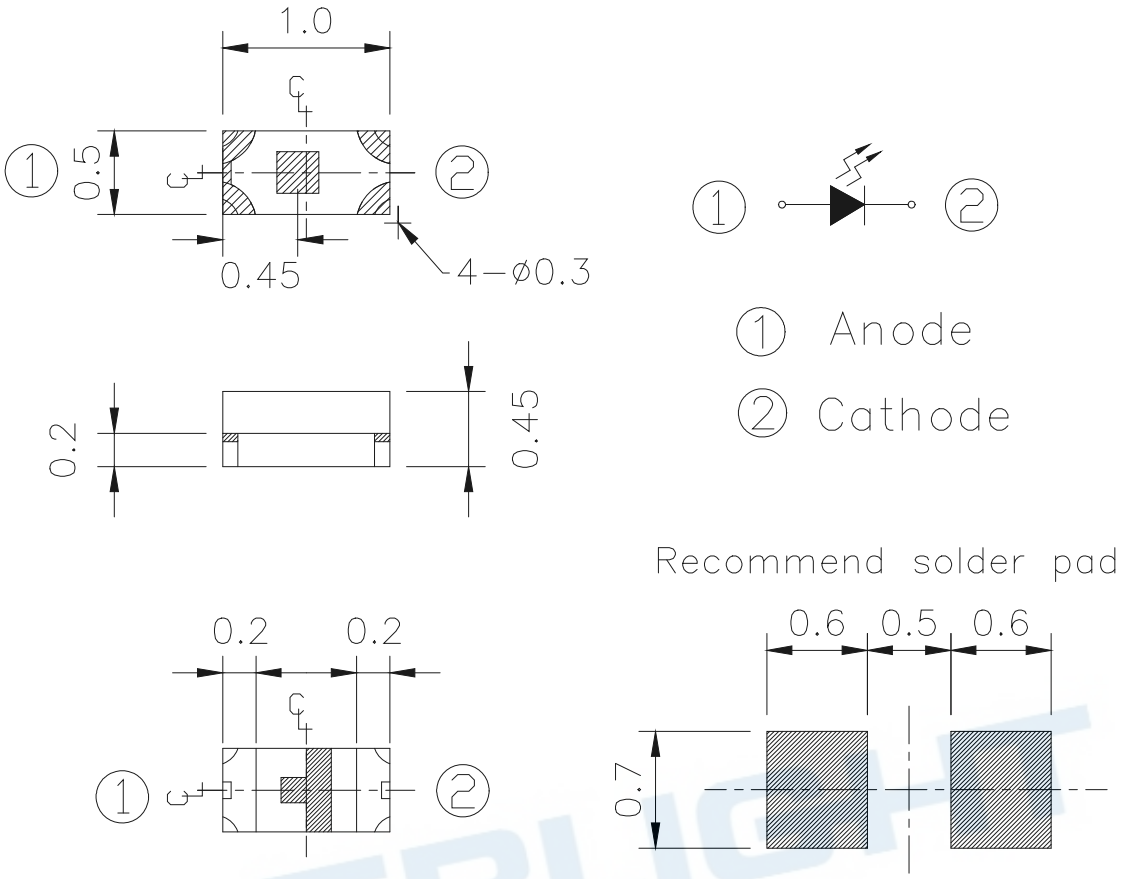
Applications

- PCB mounted infrared sensor
- Infrared remote control units with high power requirement
- Scanner
- Infrared applied system

Device Selection Guide

Device No.	Chip Material	Lens Color
HIR16-213C/L423/TR8	AlGaAs	Water Clear

Package Dimensions



Notes: 1.All dimensions are in millimeters
2.Tolerances unless dimensions ±0.1mm

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit
Continuous Forward Current	I_F	50	mA
Reverse Voltage	V_R	5	V
Operating Temperature	T_{opr}	-40 ~ +100	°C
Storage Temperature	T_{stg}	-40 ~ +100	°C
Soldering Temperature *1	T_{sol}	260	°C
Power Dissipation at(or below) 25℃ Free Air Temperature	P_c	100	mW

Notes: *1: Soldering time≦5 seconds.

Electro-Optical Characteristics (Ta=25℃ unless specified otherwise)

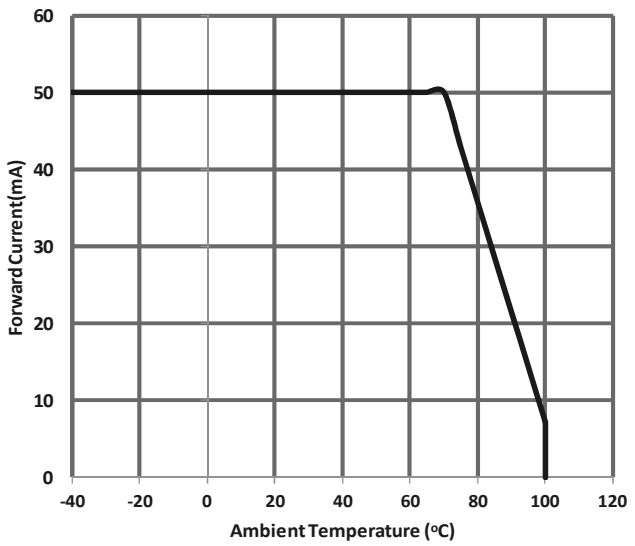
Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Radiant Intensity	I_E	0.50	1.50	--	mW/sr	I_F=20mA
Peak Wavelength	λ_p	840	850	870	nm	I_F=20mA
Spectral Bandwidth	$\Delta\lambda$	--	30	--	nm	I_F=20mA
Forward Voltage	V_F	--	1.45	1.65	V	I_F=20mA
		--	1.70	2.00	V	I_F=100mA Pulse Width≦100μs Duty≦1%
Reverse Current	I_R	--	--	10	μA	V_R=5V
View Angle	$2\theta_{1/2}$	--	145	--	Deg.	I_F=20mA

Rankings

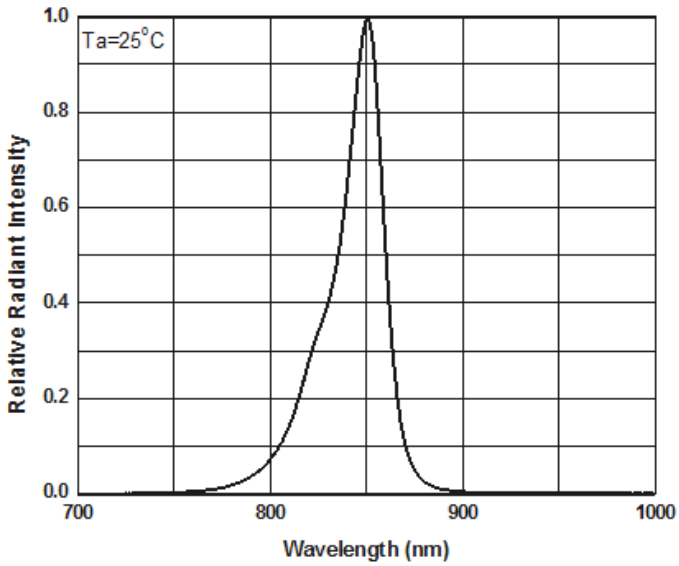
Rank	Test Condition	Min	Max	Unit
F	I_F=20mA	0.50	1.50	mW/sr
G		1.00	2.50	
H		2.00	3.50	
J		3.00	4.50	

Typical Electrical/Optical/Characteristics Curves for IR

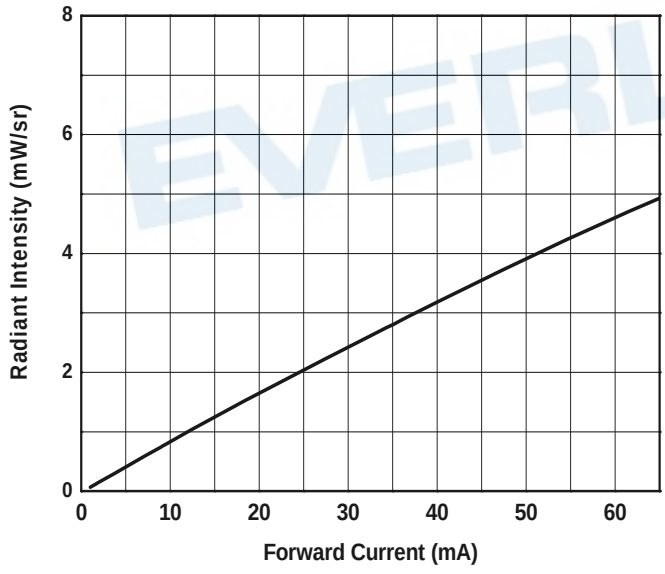
Forward Current vs. Ambient Temperature



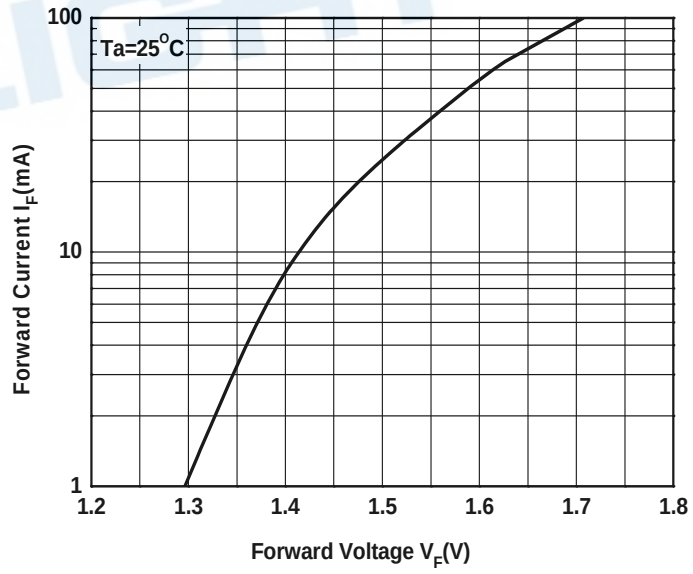
Spectral Distribution



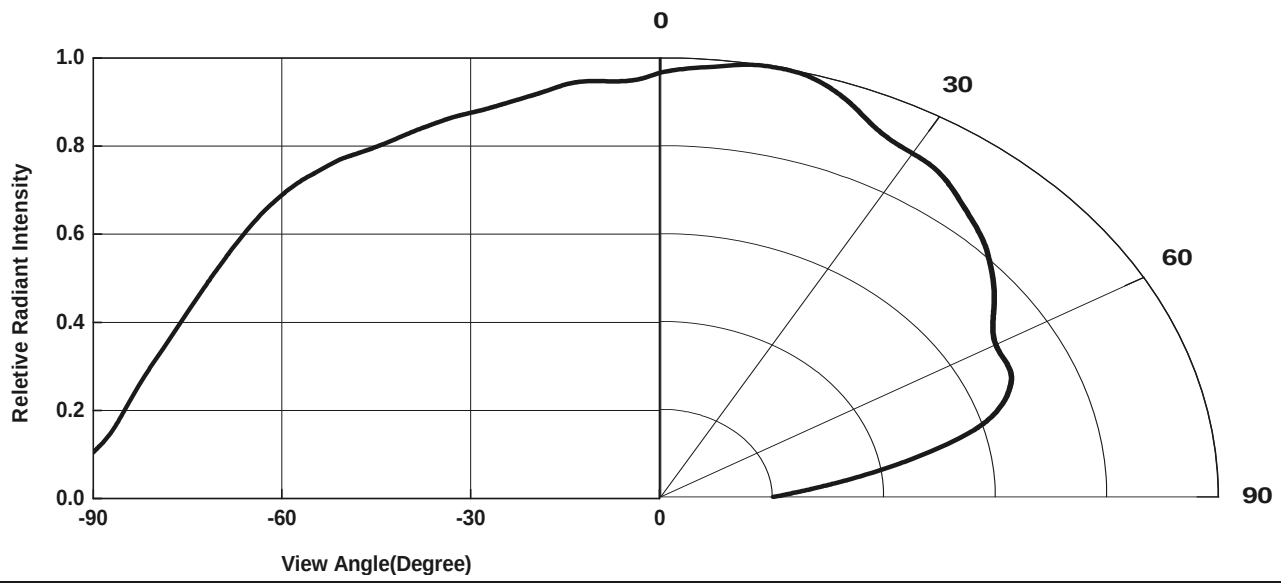
Radiant Intensity vs. Forward Current



Forward Current vs. Forward Voltage



Relative Radiant Intensity vs. Angular Displacement



Precautions For Use

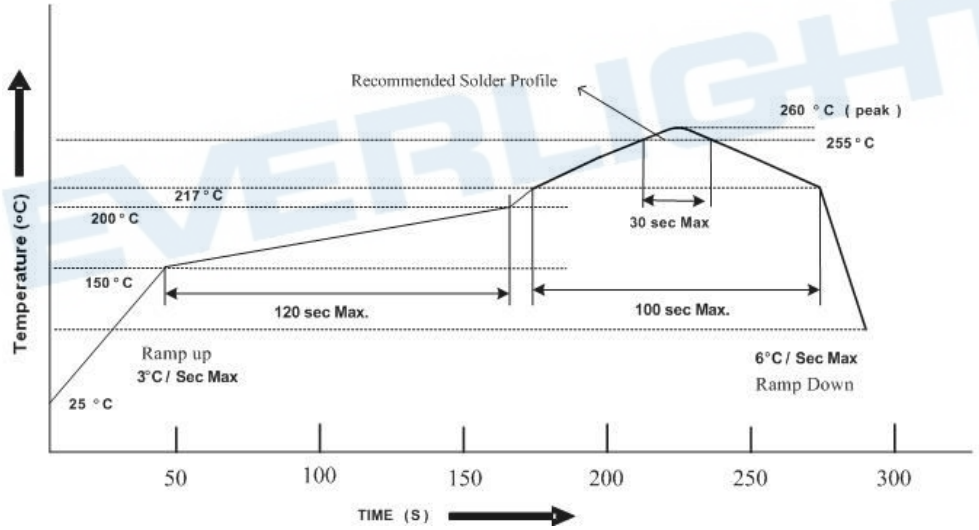
1. Over-current-proof

   Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change

   (Burn out will happen).

2. Storage
   2.1 Do not open moisture proof bag before the products are ready to use.
   2.2 Before opening the package, the LEDs should be kept at 30℃ or less and 90%RH or less.
   2.3 The LEDs should be used within a year.
   2.4 After opening the package, the LEDs should be kept at 30℃ or less and 60%RH or less.
   2.5 The LEDs should be used within 168 hours (7 days) after opening the package
   2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
   Baking treatment : 60±5℃ for Min 24 hours.

3. Soldering Condition
   3.1 Pb-free solder temperature profile



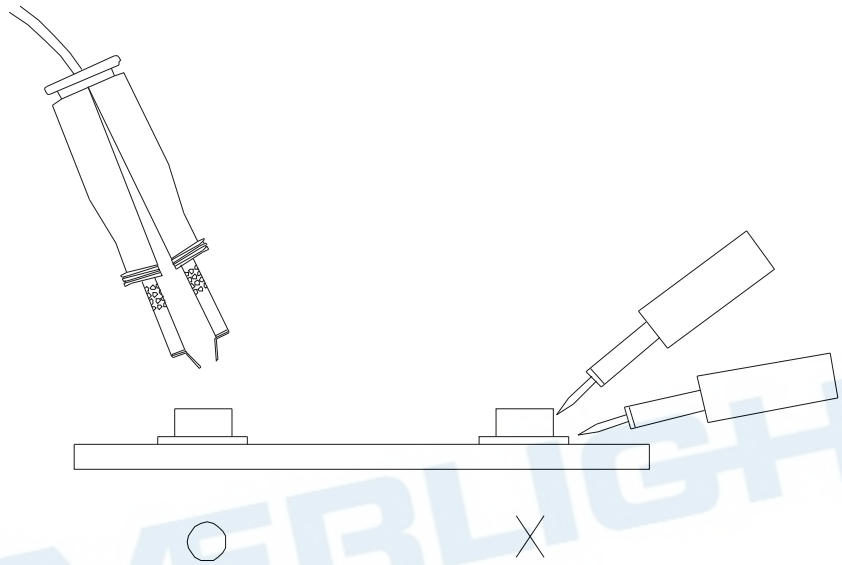
   3.2 Reflow soldering should not be done more than two times.
   3.3 When soldering, do not put stress on the LEDs during heating.
   3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

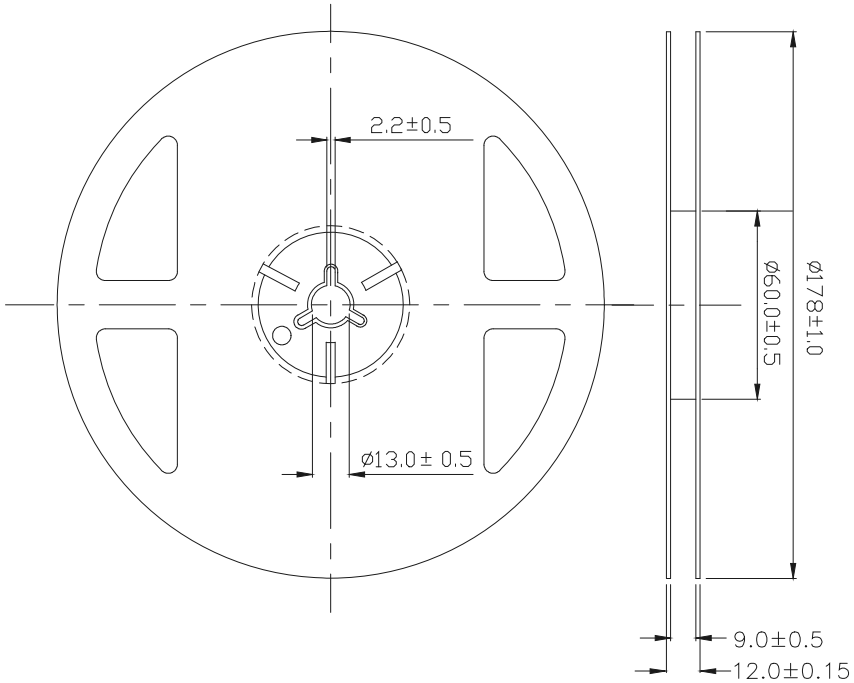
Each terminal is to go to the tip of soldering iron temperature less than 350℃ for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

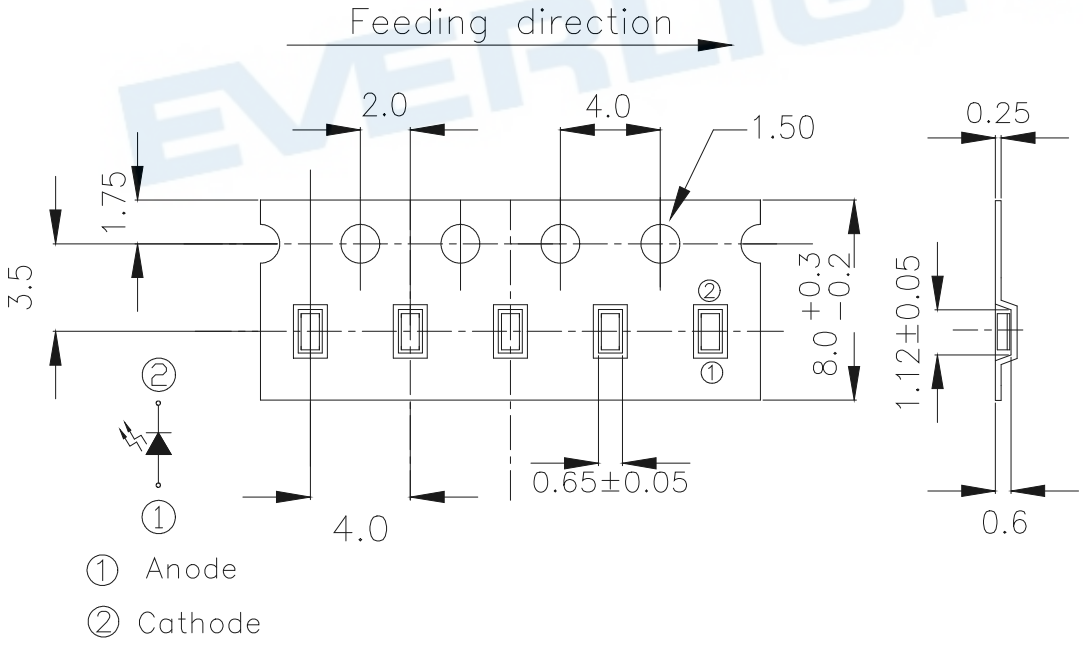


Package Dimensions



Note: The tolerances unless mentioned is ±0.1mm ,Unit = mm

Carrier Tape Dimensions :(Quantity: 3000pcs/reel)



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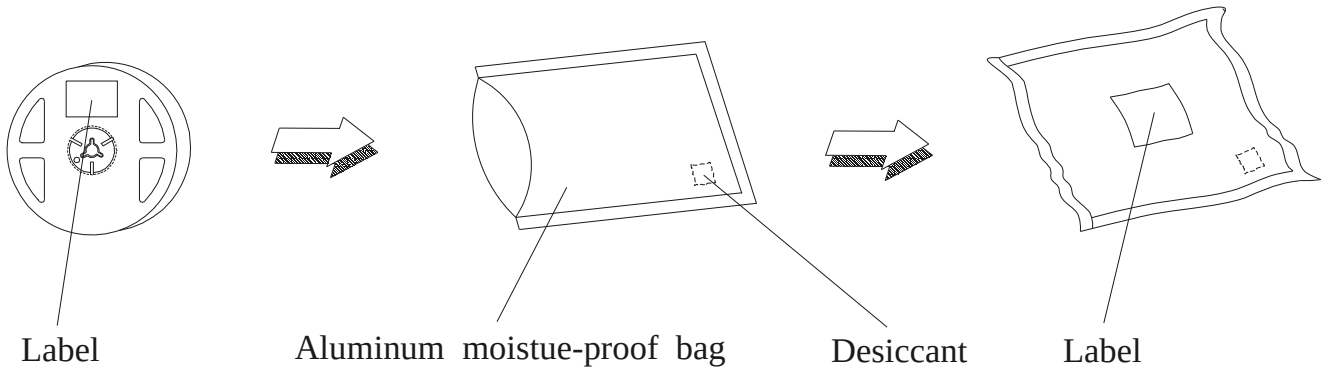
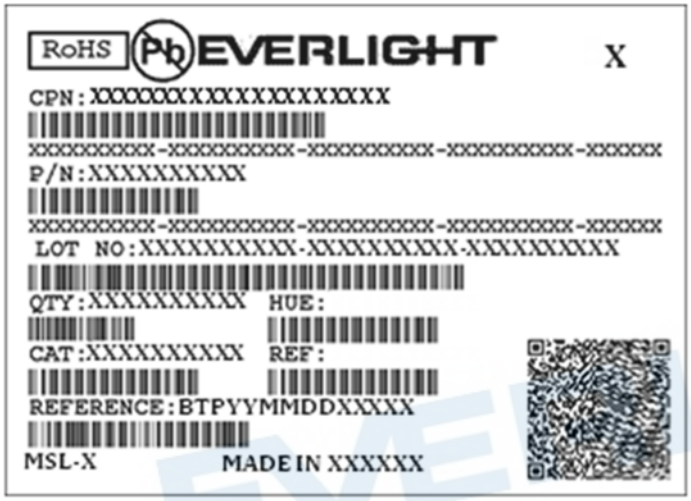
Packing Procedure



Label Form Specification



CPN: Customer's Production Number
P/N : Production Number
QTY: Packing Quantity
CAT: Ranks
HUE: Peak Wavelength
REF: Reference
LOT No: Lot Number
MADE IN TAIWAN: Production Place

DISCLAIMER

1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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